

## 5000W, 16V - 100V Surface Mount Transient Voltage Suppressor

### FEATURES

- 5000W peak pulse power capability at 10/1000 $\mu$ s waveform
- Ideal for automated placement
- Photo glass passivated chip junction
- Excellent clamping capability
- Fast response time: Typically less than 1.0ps
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

### APPLICATIONS

- I/O interface
- AC/DC power supply

### MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.300g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$V_{WM}$	16 - 100	V
$V_{BR}$ (uni-directional)	17.8 - 123	V
$P_{PPSM}$	5000	W
$T_{JMAX}$	175	°C
Package	DO-214AB (SMC)	
Configuration	Stacked die	


**DO-214AB (SMC)**


### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	VALUE	UNIT
Non-repetitive peak impulse power dissipation with 10/1000 $\mu$ s waveform <sup>(1)</sup>	$P_{PK}$	5000	W
Steady state power dissipation at $T_L = 75^\circ\text{C}$ <sup>(2)</sup>	$P_D$	6.25	W
Forward Voltage @ $I_F = 100\text{A}$ for Uni-directional only <sup>(3)</sup>	$V_F$	5	V
Junction temperature	$T_J$	-55 to +175	°C
Storage temperature	$T_{STG}$	-55 to +175	°C

#### Notes:

1. Non-repetitive current pulse per Fig.3 and derated above  $T_A = 25^\circ\text{C}$  per Fig.1
2. Units mounted on PCB (16mm x 16mm Cu pad test board)
3. Pulse test with PW = 0.3ms

### THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	16	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	61	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	17	°C/W

**Thermal Performance Note:** Units mounted on PCB (16mm x 16mm Cu pad test board)

**ELECTRICAL SPECIFICATIONS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Part number	Marking code	Breakdown voltage $V_{BR}@I_T$ (V) (Note 1)		Test current $I_T$ (mA)	Working stand-off voltage $V_{WM}$ (V)	Maximum blocking leakage current $I_{IB}@V_{WM}$ ( $\mu\text{A}$ ) (Note 1)	Maximum peak impulse current $I_{PP}$ (A)	Maximum clamping voltage $V_C@I_{PP}$ (V)	Maximum Temp. coefficient of $V_{BR}$ $\alpha V_{BR}@I_T$ (mV/ $^\circ\text{C}$ )
		Min	Max						
5.0SMDJ16A	5PET	17.8	19.7	1	16	50	193	26.0	0.096
5.0SMDJ17A	5PEU	18.9	20.9	1	17	20	181	27.6	0.097
5.0SMDJ18A	5PEV	20.0	22.1	1	18	10	172	29.2	0.098
5.0SMDJ20A	5PEW	22.2	24.5	1	20	5	155	32.4	0.099
5.0SMDJ22A	5PEX	24.4	26.9	1	22	5	141	35.5	0.100
5.0SMDJ24A	5PEZ	26.7	29.5	1	24	2	129	38.9	0.101
5.0SMDJ26A	5PFE	28.9	31.9	1	26	2	119	42.1	0.101
5.0SMDJ28A	5PFG	31.1	34.4	1	28	2	110	45.4	0.102
5.0SMDJ30A	5PFK	33.3	36.8	1	30	2	103	48.4	0.103
5.0SMDJ33A	5PFM	36.7	40.6	1	33	2	93.9	53.3	0.104
5.0SMDJ36A	5PFP	40.0	44.2	1	36	2	86.1	58.1	0.104
5.0SMDJ40A	5PFR	44.4	49.1	1	40	2	77.6	64.5	0.105
5.0SMDJ43A	5PFT	47.8	52.8	1	43	2	72.1	69.4	0.105
5.0SMDJ45A	5PFV	50.0	55.3	1	45	2	68.8	72.7	0.106
5.0SMDJ48A	5PFX	53.3	58.9	1	48	2	64.7	77.4	0.106
5.0SMDJ51A	5PFZ	56.7	62.7	1	51	2	60.7	82.4	0.107
5.0SMDJ54A	5PGE	60.0	66.3	1	54	2	57.5	87.1	0.107
5.0SMDJ58A	5PGG	64.4	71.2	1	58	2	53.5	93.6	0.107
5.0SMDJ60A	5PGK	66.7	73.7	1	60	2	51.7	96.8	0.108
5.0SMDJ64A	5PGM	71.1	78.6	1	64	2	48.6	103	0.108
5.0SMDJ70A	5PGP	77.8	86.0	1	70	2	44.3	113	0.108
5.0SMDJ75A	5PGR	83.3	92.1	1	75	2	41.4	121	0.108
5.0SMDJ78A	5PGT	86.7	95.8	1	78	2	39.7	126	0.108
5.0SMDJ85A	5PGV	94.4	104	1	85	2	36.5	137	0.110
5.0SMDJ90A	5PGX	100	111	1	90	2	34.3	146	0.110
5.0SMDJ100A	5PGZ	111	123	1	100	2	30.9	162	0.110

**Note:**

1. Pulse test with PW = 30ms

**ORDERING INFORMATION**

ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING
5.0SMDJx	DO-214AB (SMC)	3,000 / Tape & Reel

**Notes:**

1. "x" defines voltage from 16V(5.0SMDJ16A) to 100V(5.0SMDJ100A)

**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

**Fig.1 Pulse Power or Current vs. Initial Junction Temperature**



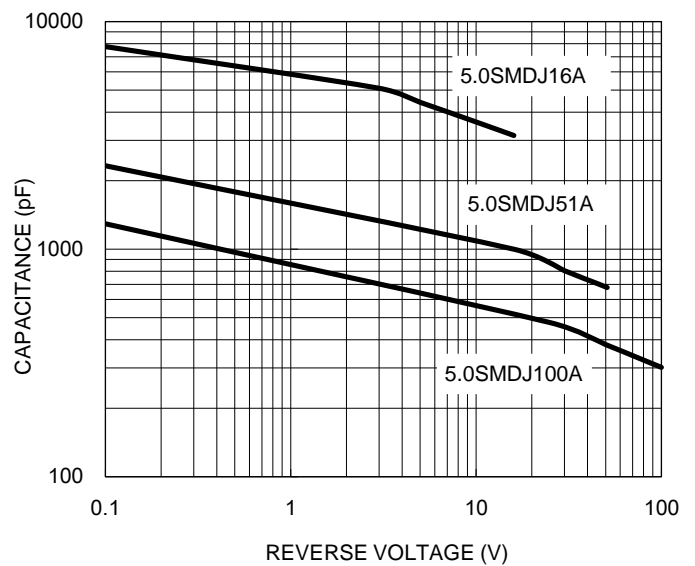
**Fig.2 Power Derating Curve**



**Fig.3 Pulse Waveform**

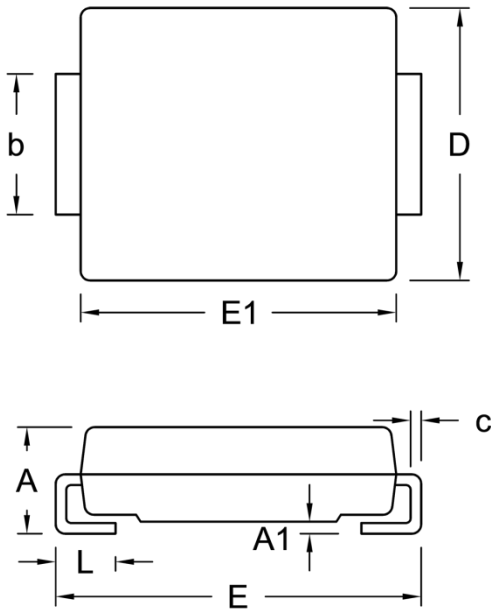


**Fig.4 Typical Junction Capacitance**



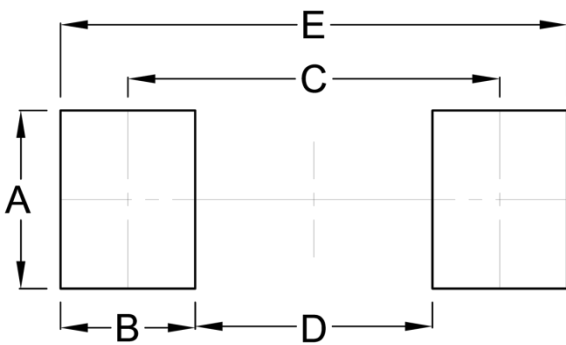
**PACKAGE OUTLINE DIMENSIONS**

DO-214AB (SMC)



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	2.00	2.62	0.079	0.103
A1	0.10	0.20	0.004	0.008
b	2.90	3.20	0.114	0.126
c	0.15	0.31	0.006	0.012
D	5.59	6.22	0.220	0.245
E	7.75	8.13	0.305	0.320
E1	6.60	7.11	0.260	0.280
L	1.00	1.60	0.039	0.063

**SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
B	2.50	0.098
C	6.90	0.272
D	4.40	0.173
E	9.40	0.370

**MARKING DIAGRAM**



- P/N = Marking Code
- G = Green Compound
- YW = Date Code
- F = Factory Code